S1A, S1B, S1D, S1G, S1J, S1K, S1M

Vishay General Semiconductor

RoHS

HALOGEN

FREE

Surface Mount Glass Passivated Rectifier



SMA (DO-214AC)

| PRIMARY CHARACTERISTICS | | | | | | | | | |
|-------------------------|--|--|--|--|--|--|--|--|--|
| I _{F(AV)} | 1.0 A | | | | | | | | |
| V _{RRM} | 50 V, 100 V, 200 V, 400 V, 600 V, 800 V, 1000 V | | | | | | | | |
| I _{FSM} | 40 A, 30 A | | | | | | | | |
| E _{AS} | 5 mJ | | | | | | | | |
| I _R | 1.0 μΑ, 5.0 μΑ | | | | | | | | |
| V _F | 1.1 V | | | | | | | | |
| T _J max. | 150 °C | | | | | | | | |
| Package | DO-214AC (SMA) | | | | | | | | |
| Diode variations | Single die | | | | | | | | |

FEATURES

- Low profile package
- Ideal for automated placement
- · Glass passivated pellet chip junction
- Low forward voltage drop
- · Low leakage current
- · High forward surge capability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available
 - Automotive ordering code: base P/NHE3 or P/NHM3
- Material categorization: for definitions of compliance please see <u>www.vishav.com/doc?99912</u>

TYPICAL APPLICATIONS

For use in general purpose rectification of power supplies, inverters, converters and freewheeling diodes for consumer, automotive, and telecommunication.

MECHANICAL DATA

Case: DO-214AC (SMA)

Molding compound meets UL 94 V-0 flammability rating Base P/N-E3 - RoHS-compliant, commercial grade Base P/N-M3 - halogen-free, RoHS-compliant, commercial grade

Base P/NHE3_X - RoHS-compliant and AEC-Q101 qualified Base P/NHM3_X - halogen-free, RoHS-compliant and AEC-Q101 qualified

("_X" denotes revision code e.g. A, B,....)

Terminals: Matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

E3, M3, HE3, and HM3 suffix meets JESD 201 class 2 whisker test

Polarity: Color band denotes cathode end

| MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted) | | | | | | | | | |
|---|-----------------------------------|--------------------|-----|-----|------|-----|-----|------|------|
| PARAMETER | SYMBOL | S1A | S1B | S1D | S1G | S1J | S1K | S1M | UNIT |
| Device marking code | | SA | SB | SD | SG | SJ | SK | SM | |
| Maximum recurrent peak reverse voltage | V _{RRM} | 50 | 100 | 200 | 400 | 600 | 800 | 1000 | V |
| Maximum RMS voltage | V _{RMS} | 35 | 70 | 140 | 280 | 420 | 560 | 700 | V |
| Maximum DC blocking voltage | V _{DC} | 50 100 200 400 600 | | 800 | 1000 | V | | | |
| Maximum average forward rectified current (fig. 1) | I _{F(AV)} | 1.0 | | | | | Α | | |
| Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load | I _{FSM} | 40 30 | | | | 0 | А | | |
| Non-repetitive peak reverse avalanche energy at 25 °C, I _{AS} = 1 A, L = 10 mH | E _{AS} | 5 | | | | | mJ | | |
| Operating junction and storage temperature range | T _J , T _{STG} | -55 to +150 | | | | | | °C | |

S1A, S1B, S1D, S1G, S1J, S1K, S1M

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| ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted) | | | | | | | | | | | |
|---|-------------------------------|-----------------------------------|-----------------|---------------------|-----|-----|-----|-----|-----|-----|------|
| PARAMETER | TEST (| CONDITIONS | SYMBOL | S1A | S1B | S1D | S1G | S1J | S1K | S1M | UNIT |
| Maximum instantaneous forward voltage | 1.0 A | | V _F | 1.1 | | | | 1.1 | | | V |
| Maximum DC reverse current | | T _A = 25 °C | I_ | 1.0 5.0 | | | | | | .0 | μA |
| at rated DC blocking voltage | | T _A = 125 °C | I _R | | | | | | | | μΛ |
| Typical reverse recovery time | $I_F = 0.5$ $I_{rr} = 0.2$ | A, I _R = 1.0 A, 5 A | t _{rr} | t _{rr} 1.8 | | | | μs | | | |
| Typical junction capacitance | 4.0 V, 1 | MHz | CJ | C _J 12 | | | | | pF | | |

| THERMAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted) | | | | | | | | | |
|---|---------------------------------------|----|--|--|--|------|----|------|------|
| PARAMETER | SYMBOL S1A S1B S1D S1G S1J S1K S1M UN | | | | | UNIT | | | |
| Typical thermal resistance (1) | $R_{\theta JA}$ | 75 | | | | | 85 | | °C/W |
| Typical thermal resistance (*) | $R_{\theta JL}$ | 27 | | | | | 3 | C/VV | |

Note

⁽¹⁾ Thermal resistance from junction to ambient and from junction to lead mounted on PCB with 0.2" x 0.2" (5.0 mm x 5.0 mm) copper pad areas

| ORDERING INFORMATION (Example) | | | | | | | | | |
|--------------------------------|-----------------|------------------------|---------------|------------------------------------|--|--|--|--|--|
| PREFERRED P/N | UNIT WEIGHT (g) | PREFERRED PACKAGE CODE | BASE QUANTITY | DELIVERY MODE | | | | | |
| S1J-E3/61T | 0.064 | 61T | 1800 | 7" diameter plastic tape and reel | | | | | |
| S1J-E3/5AT | 0.064 | 5AT | 7500 | 13" diameter plastic tape and reel | | | | | |
| S1JHE3_A/H (1) | 0.064 | Н | 1800 | 7" diameter plastic tape and reel | | | | | |
| S1JHE3_A/I (1) | 0.064 | I | 7500 | 13" diameter plastic tape and reel | | | | | |

Note

RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise noted)

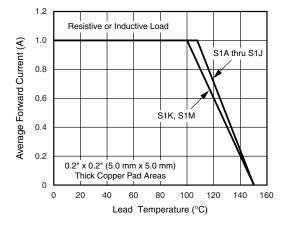


Fig. 1 - Forward Current Derating Curve

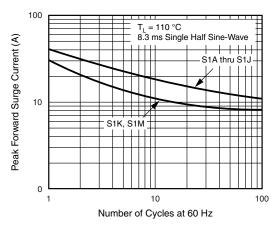


Fig. 2 - Maximum Non-Repetitive Peak Forward Surge Current

⁽¹⁾ AEC-Q101 qualified



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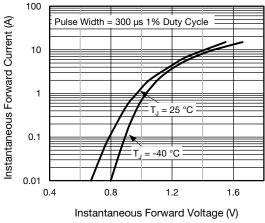


Fig. 3 - Typical Instantaneous Forward Characteristics

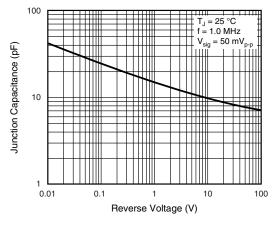


Fig. 5 - Typical Junction Capacitance

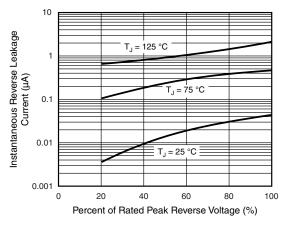


Fig. 4 - Typical Reverse Leakage Characteristics

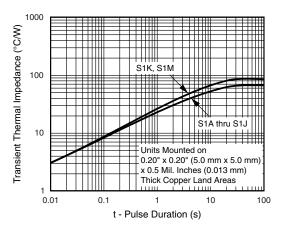
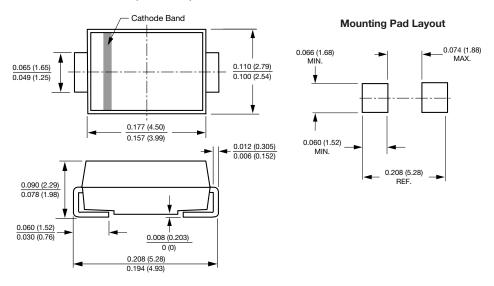


Fig. 6 - Typical Transient Thermal Impedance

PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

SMA (DO-214AC)





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